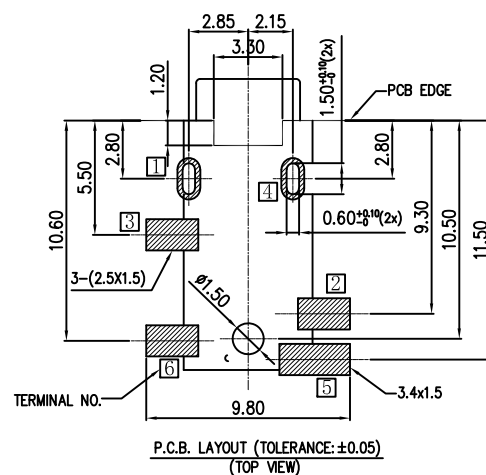
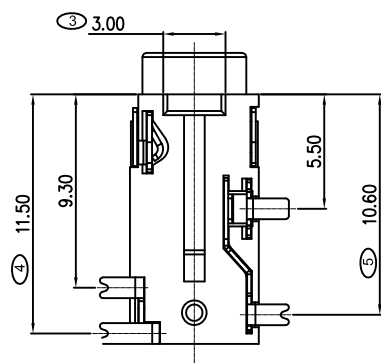
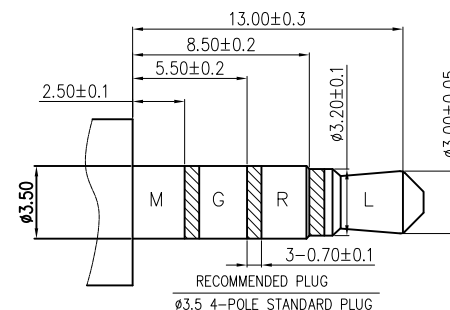
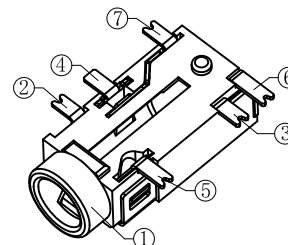
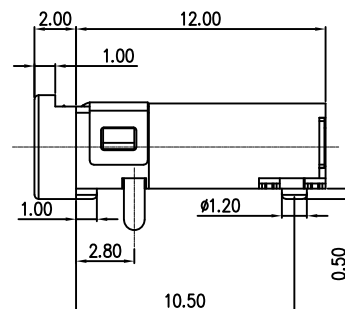
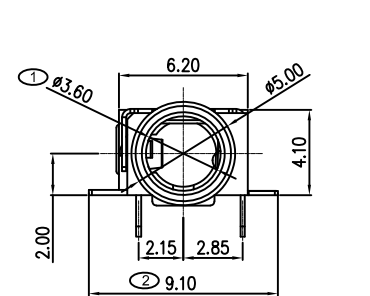




Specification:

1.Rating : DC 30V 0.5A.

2.Contact resistance: $\leq 30\text{m}\Omega$.

After test: $\leq 50\text{m}\Omega$.

3.Insulation resistance: $\geq 100\text{M}\Omega$ (500VDC).

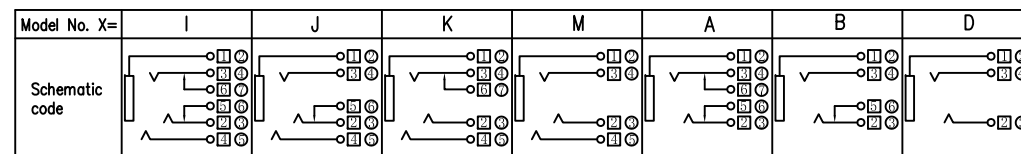
After test: $\geq 50\text{M}\Omega$.

4.Withstanding voltage: 500VAC.

5.Insertion and extraction force: 3N~30N.

6.life test: 5000cycles min.

※ SIGN “X” IS IMPORTANCE DIMENSION



Circuit Diagram

□: Terminal No. ○: Item No.

⑦	Shunt terminal	1	Copper Alloy	t=0.2	Gold plating
⑥	Shunt terminal	1	Copper Alloy	t=0.25	Gold plating
⑤	Ring spring	1	Copper Alloy	t=0.25	Gold plating
④	Ring spring	1	Copper Alloy	t=0.2	Gold plating
③	Tip spring	1	Copper Alloy	t=0.25	Gold plating
②	Earth spring	1	Copper Alloy	t=0.2	Gold plating
①	Housing	1	Hi-Tem. Thermoplastic		Black
NO.	DESCRIPTION	Q' TY	MATERIAL	REMARK	

KEM 奇速科技有限公司
Qi-Speed Technology CO., LTD.

產品名稱:
PRODUCT NAME
Ø3.5 PHONE JACK

單位: mm	繪圖	設計	審核	核准	料號: KPJS-3106K-X-3.5
比例:	DRAWING	DESIGNED	CHECKED BY	APPROVAL BY	PART NUMBER
公差: .X ±0.38 .XX ±0.30 .XXX ±0.15	JOHNY	JOHNY	LUKE	JAMES	圖號: KPJS-3106K-X-3.5-1
日期: 2022/9/7					DRAWING NO
版本	修改事項	修改日期			版本: REV. 0